

MOS FIELD EFFECT TRANSISTOR $\mu PA1716$

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is P-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

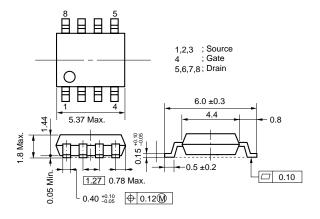
FEATURES

- Low on-resistance
- Low Ciss : Ciss = 2100 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE		
μ PA1716G	Power SOP8		

PACKAGE DRAWING (Unit : mm)



ABSOLUTE MAXIMUM RATINGS (TA	a = 25°C, A	All terminals are	e connected.)	EQUIVARENT CIRCUIT
Drain to Source Voltage (Vgs = 0 V)	Vdss	-30	V	Drain
Gate to Source Voltage (VDs = 0 V)	Vgss	∓ 20	V	• •
Drain Current (DC)	D(DC)	Ŧ 8	А	Body
Drain Current (pulse) ^{Note1}	D(pulse)	∓ 32	А	
Total Power Dissipation $(T_A = 25^{\circ}C)^{Note2}$	Р⊤	2.0	W	
Channel Temperature	Tch	150	°C	Gate J Protection Source
Storage Temperature	Tstg	–55 to +150	°C	Diode

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

- 2. Mounted on ceramic substrate of 1200 mm² x 1.0 mm
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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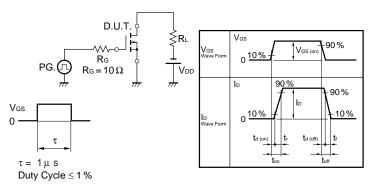
G13727EJ1V0DS00 (1st edition) March 1999 NS CP(K)

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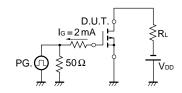
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -10 \text{ V}, \text{ ID} = -4.0 \text{ A}$		12.5	16	mΩ
	RDS(on)2	V _{GS} = −4.5 V, I _D = −4.0 A		17	23	mΩ
	RDS(on)3	$V_{GS} = -4.0 \text{ V}, \text{ Id} = -4.0 \text{ A}$		19	26	mΩ
Gate to Source Cut-off Voltage	VGS(off)	$V_{DS} = -10 V$, $I_D = -1 mA$	-1.0	-1.6	-2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = -10 V, I _D = -4.0 A	7	14		S
Drain Leakage Current	loss	VDS = -30 V, $VGS = 0 V$			-1	μΑ
Gate to Source Leakage Current	lgss	$V_{GS} = \overline{+} 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			∓ 10	μA
Input Capacitance	Ciss	$V_{DS} = -10 V$		2100		pF
Output Capacitance	Coss	V _{GS} = 0 V f = 1 MHz		700		pF
Reverse Transfer Capacitance	Crss			300		pF
Turn-on Delay Time	td(on)	ID = -4.0 A		30		ns
Rise Time	tr	$V_{GS(on)} = -10 V$		150		ns
Turn-off Delay Time	td(off)	$V_{DD} = -15 V$		120		ns
Fall Time	tr	R _G = 10 Ω		76		ns
Total Gate Charge	QG	$I_D = -8.0 \text{ A}$ $V_{DD} = -24 \text{ V}$ $V_{GS} = -10 \text{ V}$		40		nC
Gate to Source Charge	QGS			6		nC
Gate to Drain Charge	Qgd			10		nC
Body Diode Forward Voltage	VF(S-D)	IF = 8.0 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 8.0 A, VGs = 0 V		45		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µ s		33		nC

ELECTRICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

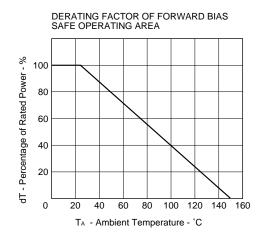
TEST CIRCUIT 1 SWITCHING TIME

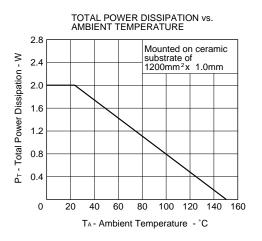


TEST CIRCUIT 2 GATE CHARGE

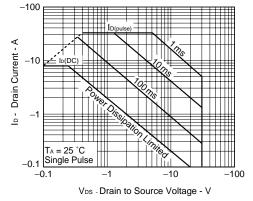


TYPICAL CHARACTERISTICS (TA = 25 °C)

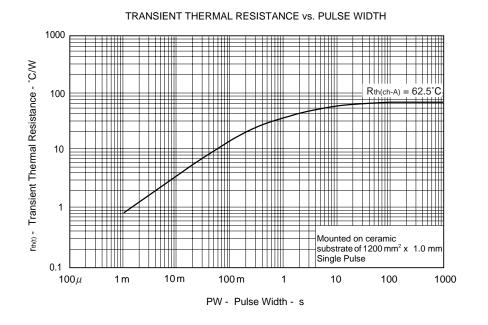




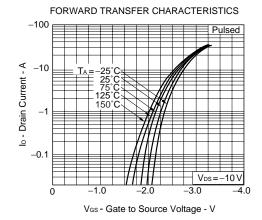
FORWARD BIAS SAFE OPERATING AREA

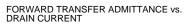


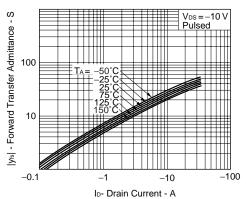
Remark Mounted on ceramic substrate of 1200 mm² x 1.0 mm

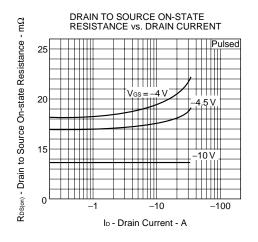


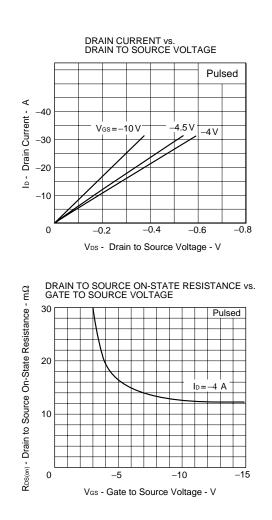


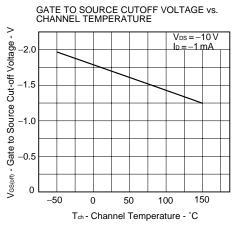








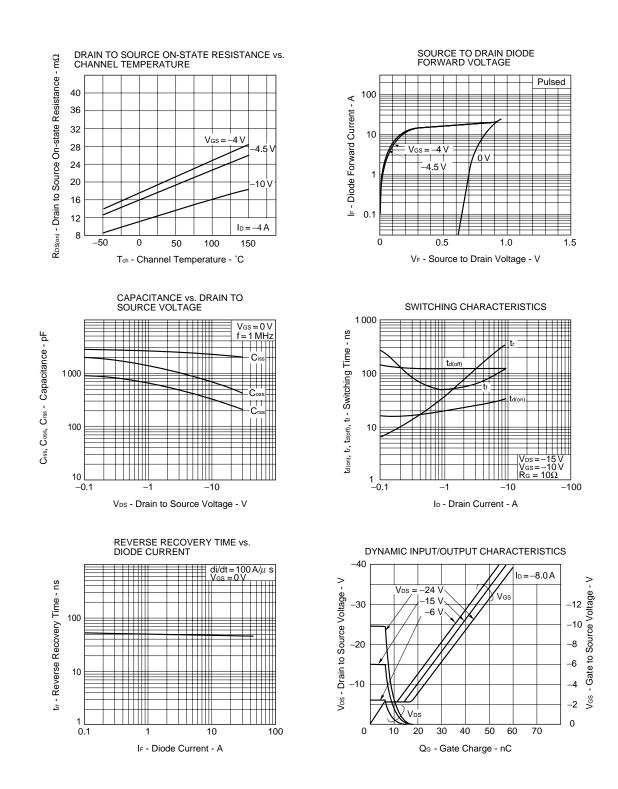




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